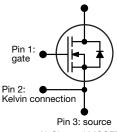
Vishay Siliconix



E Series Power MOSFET





N-Channel MOSFET

PRODUCT SUMMARY					
V _{DS} (V) at T _J max.	650				
R _{DS(on)} typ. (Ω) at 25 °C	$V_{GS} = 10 V$	0.135			
Q _g max. (nC)	36				
Q _{gs} (nC)	10				
Q _{gd} (nC)	6				
Configuration	Single				

Pin 4: drain

• 4th generation E series technology

FEATURES

- Low figure-of-merit (FOM) R_{on} x Q_g
- Low effective capacitance (Co(er))
- Reduced switching and conduction losses
- Avalanche energy rated (UIS)
- Material categorization: for definitions of compliance please see <u>www.vishay.com/doc?99912</u>

APPLICATIONS

- Server and telecom power supplies
- Switch mode power supplies (SMPS)
- Power factor correction power supplies (PFC)
- Lighting
 - High-intensity discharge (HID)
 - Fluorescent ballast lighting
- Industrial
 - Welding
 - Induction heating
 - Motor drives
 - Battery chargers
 - Solar (PV inverters)

ORDERING INFORMATION	
Package	PowerPAK [®] 8 x 8
Lead (Pb)-free and halogen-free	SiHH150N60E-T1-GE3

ABSOLUTE MAXIMUM RATINGS ($T_C = 25 \text{ °C}$, unless otherwise noted)						
PARAMETER			SYMBOL	LIMIT	UNIT	
Drain-source voltage			V _{DS}	600	v	
Gate-source voltage			V _{GS}	± 30	- V	
Continuous drain current (T _J = 150 °C)	V at 10 V	T _C = 25 °C		19		
	V _{GS} at 10 V	T _C = 100 °C	I _D	12	А	
Pulsed drain current ^a			I _{DM}	43		
Linear derating factor				1.04	W/°C	
Single pulse avalanche energy ^b			E _{AS}	179	mJ	
Maximum power dissipation			PD	156	W	
Operating junction and storage temperature ra	inge		T _J , T _{stg}	-55 to +150	°C	
Drain-source voltage slope		T _J = 125 °C	dy /dt	100	V/ns	
Reverse diode dv/dt ^d		dv/dt	5	v/ns		

Notes

a. Repetitive rating; pulse width limited by maximum junction temperature

- b. V_{DD} = 120 V, starting T_J = 25 °C, L = 28.2 mH, R_g = 25 Ω , I_{AS} = 2.8 A
- c. $I_{SD} \leq I_D, \, di/dt$ = 100 A/µs, starting T_J = 25 $^\circ C$

RoHS

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PARAMETER	SYMBOL	TYP.		MAX.		UNIT	
Maximum junction-to-ambient	R _{thJA}	42		55			
Maximum junction-to-case (drain)	R _{thJC}	0.72 0.96			°C/W		
SPECIFICATIONS ($T_J = 25 \ ^{\circ}C$,						T	1
PARAMETER	SYMBOL	TES	T CONDITIONS	MI	N. TYP.	MAX.	UNI
Static						T	
Drain-source breakdown voltage	V _{DS}	20	= 0 V, I _D = 250 μA	60	-	-	V
V _{DS} temperature coefficient	$\Delta V_{DS}/T_{J}$		e to 25 °C, I _D = 1 n	nA -	0.62	-	V/°(
Gate-source threshold voltage (N)	V _{GS(th)}		= V _{GS} , I _D = 250 μA	3.0	0 -	5.0	V
Gate-source leakage	I _{GSS}		$V_{GS} = \pm 20 V$	-	-	± 100	nA
	-635		$V_{GS} = \pm 30 V$	-	-	± 1	μA
Zero gate voltage drain current	lace	-	$V_{DS} = 600 \text{ V}, \text{ V}_{GS} = 0 \text{ V}$		-	1	μA
	I _{DSS}	V _{DS} = 480 V	$V_{\rm H}, V_{\rm GS} = 0 \ V, \ T_{\rm J} = 12$	25 °C -	-	10	μΛ
Drain-source on-state resistance	R _{DS(on)}	$V_{GS} = 10 V$	I _D = 10 A	-	0.135	0.155	Ω
Forward transconductance ^a	9 _{fs}	V _{DS}	= 10 V, I _D = 10 A	-	5.1	-	S
Dynamic							
Input capacitance	C _{iss}		V _{GS} = 0 V,		1514	-	
Output capacitance	C _{oss}	$V_{DS} = 100 V,$		-	60	-	
Reverse transfer capacitance	C _{rss}		f = 100 KHz		2	-	
Effective output capacitance, energy related	C _{o(er)}	V_{DS} = 0 V to 400 V, V_{GS} = 0 V		-	58	-	pF
Effective output capacitance, time related	C _{o(tr)}			-	322	-	1
Total gate charge	Qg			-	24	36	
Gate-source charge	Q _{gs}	$V_{GS} = 10 \text{ V}$ $I_D = 10 \text{ A}, V_{DS} = 480 \text{ V}$		480 V -	10	-	nC
Gate-drain charge	Q _{gd}				6	-	
Turn-on delay time	t _{d(on)}			-	20	40	
Rise time	t _r		V_{DD} = 480 V, I _D = 10 A, V _{GS} = 10 V, R _g = 9.1 Ω		27	54	ns
Turn-off delay time	t _{d(off)}				28	56	
Fall time	t _f	1		-	17	34	
Gate input resistance	Rg	f = 1 MHz, open drain		0.4	4 0.9	1.8	Ω
Drain-Source Body Diode Characterist	· · · ·						1
Continuous source-drain diode current	I _S	MOSFET symbol showing the integral reverse p - n junction diode			-	22	Γ.
Pulsed diode forward current	I _{SM}				-	43	A
Diode forward voltage	V _{SD}	T _J = 25 °C, I _S = 10 A, V _{GS} = 0 V		0 V -	-	1.2	V
Reverse recovery time	t _{rr}	$T_{J} = 25 \text{ °C}, I_{F} = I_{S} = 10 \text{ A},$ di/dt = 100 A/µs, V _R = 25 V		-	291	582	ns
Reverse recovery charge	Q _{rr}				3.5	7.0	μΟ
Reverse recovery current	I _{RRM}			-	21	-	A

2

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TYPICAL CHARACTERISTICS (25 °C, unless otherwise noted)

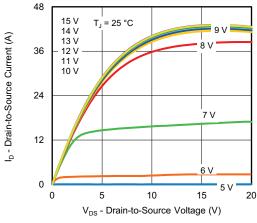


Fig. 1 - Typical Output Characteristics

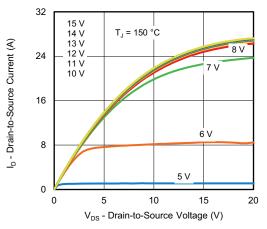


Fig. 2 - Typical Output Characteristics

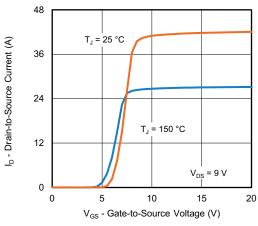


Fig. 3 - Typical Transfer Characteristics

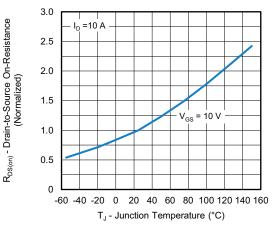


Fig. 4 - Normalized On-Resistance vs. Temperature

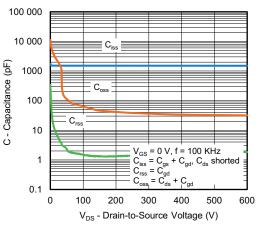


Fig. 5 - Typical Capacitance vs. Drain-to-Source Voltage

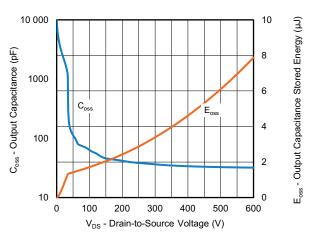


Fig. 6 - C_{oss} and E_{oss} vs. V_{DS}

S22-1034-Rev. A, 12-Dec-2022

3 questions contact: hym@vis Document Number: 92453

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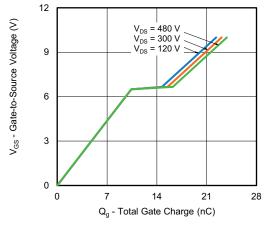


Fig. 7 - Typical Gate Charge vs. Gate-to-Source Voltage

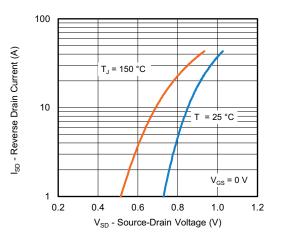


Fig. 8 - Typical Source-Drain Diode Forward Voltage

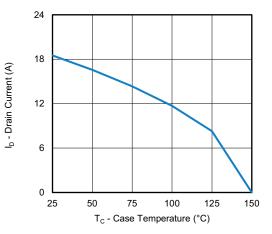


Fig. 9 - Maximum Drain Current vs. Case Temperature

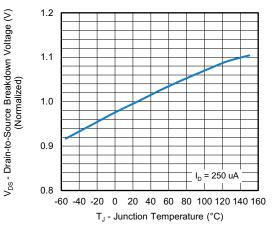


Fig. 10 - Temperature vs. Drain-to-Source Voltage

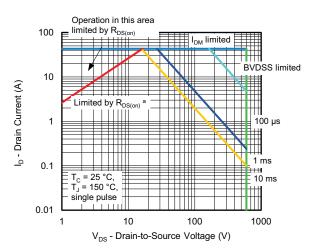


Fig. 11 - Maximum Safe Operating Area

Note

d. V_{GS} > minimum V_{GS} at which $R_{DS(on)}$ is specified

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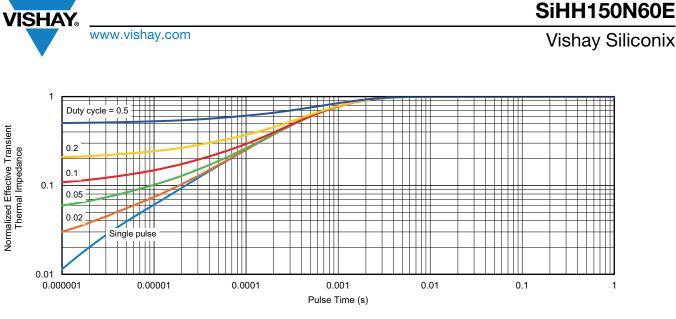


Fig. 12 - Normalized Transient Thermal Impedance, Junction-to-Case

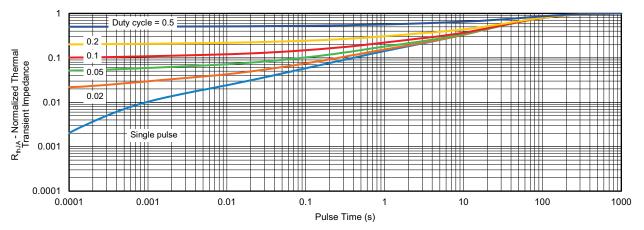


Fig. 13 - Normalized Transient Thermal Impedance, Junction-to-Ambient

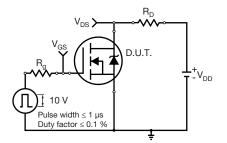


Fig. 14 - Switching Time Test Circuit

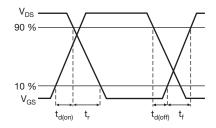


Fig. 15 - Switching Time Waveforms



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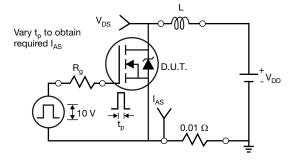


Fig. 16 - Unclamped Inductive Test Circuit

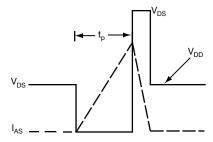


Fig. 17 - Unclamped Inductive Waveforms

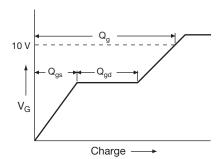


Fig. 18 - Basic Gate Charge Waveform

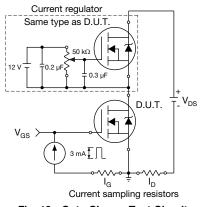


Fig. 19 - Gate Charge Test Circuit



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Peak Diode Recovery dv/dt Test Circuit

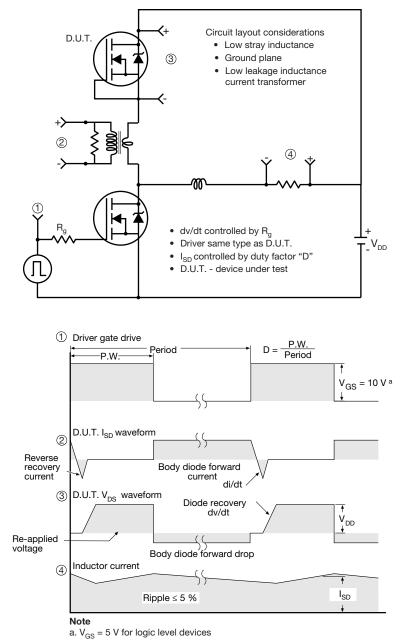


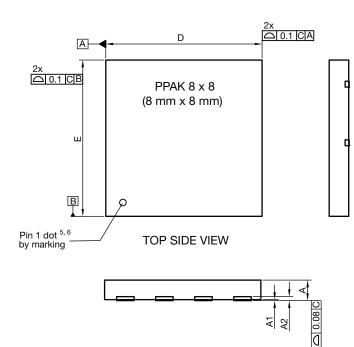
Fig. 20 - For N-Channel

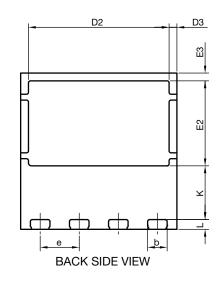
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PowerPAK[®] 8 x 8 Case Outline





DIM		MILLIMETERS			INCHES			
DIM. MIN	MIN.	NOM.	MAX.	MIN.	NOM.	MAX.		
А	0.95	1.00	1.05	0.037	0.039	0.041		
A1	0.00	-	0.05	0.000	-	0.002		
A2	020 ref.			0.008 ref.				
b	0.95	1.00	1.05	0.037	0.039	0.041		
D	7.90	8.00	8.10	0.311	0.315	0.319		
D2	7.10	7.20	7.30	0.280	0.283	0.287		
D3	0.40 BSC			0.016 BSC				
е	2.00 BSC		0.079 BSC					
E	7.90	8.00	8.10	0.311	0.315	0.319		
E2	4.30	4.35	4.40	0.169	0.171	0.173		
E3	0.40 BSC		0.016 BSC					
К	2.75 BSC		0.108 BSC					
L	0.45	0.50	0.55	0.018	0.020	0.022		
N ⁽³⁾	8			8				

Notes

⁽¹⁾ Use millimeters as the primary measurement

⁽²⁾ Dimensioning and tolerances conform to ASME Y14.5 M - 1994

⁽³⁾ N is the number of terminals

⁽⁴⁾ The pin 1 identifier must be existed on the top surface of the package by using indentation mark or other feature of package body

⁽⁵⁾ Exact shape and size of this feature is optional

ECN: E20-0518-Rev. B, 28-Sep-2020 DWG: 6041

Revision: 28-Sep-2020

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Recommended Minimum PADs for PowerPAK[®] 8 mm x 8 mm



Dimensions in millimeters

Document Number: 68441



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